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Part Number:

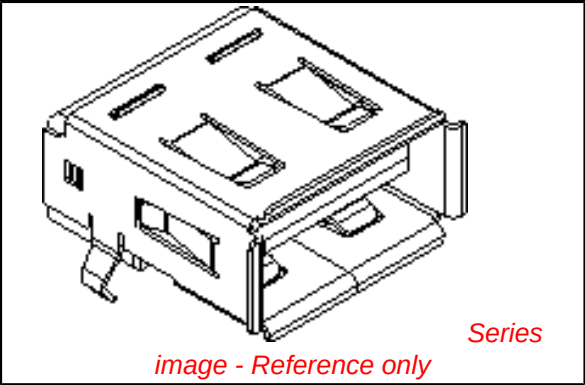
0676433911

Status:

Active

Description:

Universal Serial Bus (USB) Shielded I/O Receptacle, Right Angle, Type A, High-Temperature White Nylon, 0.76µm (30µ") Gold (Au) Plating, PCB Thickness 1.60mm (.063"), without Upper Flange, for IR Reflow Process, Lead Free



Documents:

3D Model

Drawing (PDF)

Product Specification PS-67643-002 (PDF)

RoHS Certificate of Compliance (PDF)

General	
Product Family	I/O Connectors
Series	67643
Application	Wire-to-Board
Comments	Without Upper Flange For IR Reflow Process
Component Type	Receptacle
Product Name	USB
Type	A
Physical	
Boot Color	N/A
Circuits (Loaded)	4
Circuits (maximum)	4
Gender	Receptacle
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Number of Rows	1
Orientation	Right Angle
PC Tail Length (in)	0.102 In
PC Tail Length (mm)	2.60 mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness Recommended (in)	0.062 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tray
Panel Mount	Yes
Pitch - Mating Interface (in)	0.079 In, 0.098 In
Pitch - Mating Interface (mm)	2.00 mm, 2.50 mm
Pitch - Term. Interface (in)	0.079 In, 0.098 In
Pitch - Term. Interface (mm)	2.00 mm, 2.50 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.76
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	1
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40°C to +85°C
Termination Interface: Style	Through Hole
Waterproof / Dustproof	No
Electrical	
Current - Maximum per Contact	1.5A
Shield Type	Full Shield
Shielded	Yes

EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Not Reviewed

Halogen-Free

Status

Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

67643Series

Mates With

USB Type A Plug

Voltage - Maximum

30V DC

Solder Process Data

Lead-free Process Capability

SMC & Wave Capable (TH only)

Process Temperature max. C

260

Material Info

Reference - Drawing Numbers

Product Specification

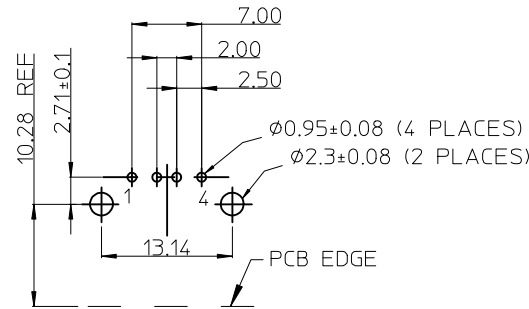
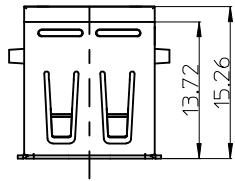
PS-67643-002

Sales Drawing

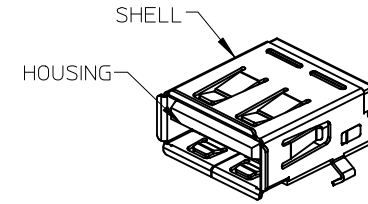
SD-67643-003

This document was generated on 04/01/2010

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PCB LAYOUT (TOP VIEW)



NOTES:

1. MATERIAL:

- ① METAL SHELL: COPPER ALLOY.
- ② HOUSING: SEE CHART, 30% GLASS FIBER FILLED, UL94-V0.
- ③ TERMINAL: PHOSPHOR BRONZE

2. TERMINAL:

CONTACT AREA: (a) GOLD FLASH.

(b) GOLD (Au), THICKNESS=30 MICROINCH MINIMUM.
SOLDER TAIL: TIN PLATED, THICKNESS=75 MICROINCH MINIMUM.
UNDER PLATED: NICKEL (Ni), THICKNESS=50 MICROINCH MINIMUM.
METAL SHELL: SEE CHART.

3. RECOMMENDED PCB THICKNESS: SEE CHART

4. PRODUCT SPECIFICATION: FOR IR REFER TO PS-67643-002

FOR NON IR REFER TO PS-67643-003

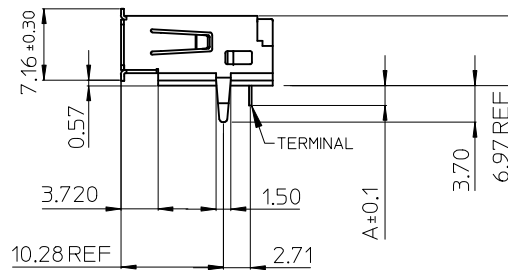
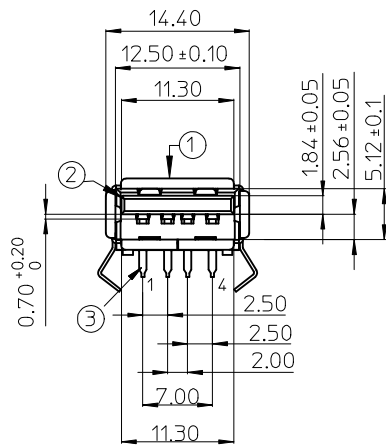
5. TORQUE FORCE SPEC: 2.50kg-cm Min, MEASURED AT BROKEN POINT.

6. TEST SUMMARY: FOR IR REFER TO TS-67643-002

FOR NON IR REFER TO TS-67643-003

7. PACKAGE: REFER TO PK-67643-002

8. LEAD FREE AND ROHS COMPLIANT PRODUCT



REVISED EC NO: DRWN: YPWU CHKD: APPR:	2009/08/28	DESCRIPTION	QUALITY SYMBOLS ▽=0 ◻=0	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION					
					mm	INCH	DRAWN BY IVY-LIN		DATE 2005/03/31		TITLE USB A TYPE RCPT SINGLE RA THROUGH HOLE W/OFLG (LEAD-FREE VERSION)					
				4 PLACES	± ---	± ---	CHECKED BY		DATE							
				3 PLACES	± ---	± ---	ALL IN		2005/03/31							
				2 PLACES	± 0.25	± ---	APPROVED BY		DATE							
				1 PLACE	± 0.25	± ---	MWSCHANG		2005/03/31		molex MOLEX INCORPORATED					
				ANGULAR ± 3 °			MATERIAL NO.		DOCUMENT NO.		SD-67643-003		SHEET NO. 1 OF 2			
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SEE SHEET2									
							SIZE A4	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								

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P/N	HOUSING MATERIAL	COLOR	CONTACT PLATING	METAL SHELL PLATING	REMARK
67643-0910	POLYESTER	BLACK	GOLD FLASH	IR REFLOW PROCESS MATTE TIN PLATED AT SOLDER AREA THICKNESS=100 MICROINCH MINIMUM UNDER PLATE:NICKEL (Ni),(SOLDERING AVAILABLE)	NON IR
67643-1910	POLYESTER	WHITE			REFLOW PROCESS
67643-2910	HIGH TEMPERATURE NYLON	BLACK			FOR IR
67643-3910	HIGH TEMPERATURE NYLON	WHITE			REFLOW PROCESS
67643-0911	POLYESTER	BLACK	GOLD PLATING 30 MICROINCH	NON IR REFLOW PROCESS: MATTE TIN PLATED. THICKNESS=80 MICROINCH MINIMUM UNDER PLATE:NICKEL (Ni).	NON IR
67643-1911	POLYESTER	WHITE			REFLOW PROCESS
67643-2911	HIGH TEMPERATURE NYLON	BLACK			FOR IR
67643-3911	HIGH TEMPERATURE NYLON	WHITE			REFLOW PROCESS
PCB THICKNESS		1.60±0.05			
DIMENSION "A"		2.60			

P/N	HOUSING MATERIAL	COLOR	CONTACT PLATING	METAL SHELL PLATING	REMARK
67643-0930	HIGH TEMPERATURE NYLON	BLACK	GOLD FLASH	FOR IR REFLOW PROCESS MATTE TIN PLATED AT SOLDER AREA THICKNESS=100 MICROINCH MINIMUM UNDER PLATE:NICKEL (Ni),(SOLDERING AVAILABLE)	FOR IR REFLOW PROCESS
67643-1930	HIGH TEMPERATURE NYLON	WHITE			
67643-0931	HIGH TEMPERATURE NYLON	BLACK	GOLD PLATING		
67643-1931	HIGH TEMPERATURE NYLON	WHITE	30 MICROINCH		
PCB THICKNESS		1.20±0.05			
DIMENSION "A"		2.00			

REVISED EC NO: DRWN:YPU CHKD: APPR:	2009/08/28	DESCRIPTION REV	QUALITY SYMBOLS ▽=0 ▽C=0	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION		
					mm	INCH	DRAWN BY	DATE	TITLE				
				4 PLACES	± ---	± ---	IVY-LIN	2005/03/31	USB A TYPE RCPT SINGLE RA THROUGH HOLE W/OFLG (LEAD-FREE VERSION)				
				3 PLACES	± ---	± ---	CHECKED BY	DATE					
				2 PLACES	± 0.25	± ---	ALL IN	2005/03/31	MOLEX INCORPORATED				
				1 PLACE	± 0.25	± ---	APPROVED BY	DATE					
				ANGULAR ± 3 °			WWSCHANG	2005/03/31	DOCUMENT NO.			SHEET NO.	
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO.		SD-67643-003			2 OF 2	
							SEE TABLE						
							SIZE A 4	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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